# DALLAS JUX

# DS1225AB/AD 64k Nonvolatile SRAM

#### www.maxim-ic.com

#### **FEATURES**

- 10 years minimum data retention in the absence of external power
- Data is automatically protected during power loss
- Directly replaces 8k x 8 volatile static RAM or EEPROM
- Unlimited write cycles
- Low-power CMOS
- JEDEC standard 28-pin DIP package
- Read and write access times as fast as 70 ns
- Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Full ±10% V<sub>CC</sub> operating range (DS1225AD)
- Optional ±5% V<sub>CC</sub> operating range (DS1225AB)
- Optional industrial temperature range of -40°C to +85°C, designated IND

## **PIN ASSIGNMENT**

NC	<b>1</b>	28	VCC
A12	$\square_2$	27	WE
A7	∎3	26	NC
A6	∎4	25	A8
A5	∎5	24	A9
A4	6	23	A11
A3	<b>1</b> 7	22	ŌĒ
A2	∎8	21	A10
A1	∎9	20	CE
A0	10	19	DQ7
DQ0	<b>1</b> 11	18	DQ6
DQ1	12	17	DQ5
DQ2	<b>1</b> 3	16	DQ4
GND	<b>1</b> 4	15	DQ3

28-Pin ENCAPSULATED PACKAGE 720-mil EXTENDED

#### **PIN DESCRIPTION**

A0-A12	- Address Inputs
DQ0-DQ7	- Data In/Data Out
$\overline{CE}$	- Chip Enable
WE	- Write Enable
ŌĒ	- Output Enable
V <sub>CC</sub>	- Power (+5V)
GND	- Ground
NC	- No Connect

# DESCRIPTION

The DS1225AB and DS1225AD are 65,536-bit, fully static, nonvolatile SRAMs organized as 8192 words by 8 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry which constantly monitors  $V_{CC}$  for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. The NV SRAMs can be used in place of existing 8k x 8 SRAMs directly conforming to the popular bytewide 28-pin DIP standard. The devices also match the pinout of the 2764 EPROM and the 2864 EEPROM, allowing direct substitution while enhancing performance. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

# **READ MODE**

The DS1225AB and DS1225AD execute a read cycle whenever  $\overline{WE}$  (Write Enable) is inactive (high) and  $\overline{CE}$  (Chip Enable) and  $\overline{OE}$  (Output Enable) are active (low). The unique address specified by the 13 address inputs (A<sub>0</sub> -A<sub>12</sub>) defines which of the 8192 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t<sub>ACC</sub> (Access Time) after the last address input signal is stable, providing that  $\overline{CE}$  and  $\overline{OE}$  access times are also satisfied. If  $\overline{CE}$  and  $\overline{OE}$  access times are not satisfied, then data access must be measured from the later-occurring signal and the limiting parameter is either t<sub>CO</sub> for  $\overline{CE}$  or t<sub>OE</sub> for  $\overline{OE}$  rather than address access.

# WRITE MODE

The DS1225AB and DS1225AD execute a write cycle whenever the  $\overline{WE}$  and  $\overline{CE}$  signals are active (low) after address inputs are stable. The later-occurring falling edge of  $\overline{CE}$  or  $\overline{WE}$  will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of  $\overline{CE}$  or  $\overline{WE}$ . All address inputs must be kept valid throughout the write cycle. WE must return to the high state for a minimum recovery time (t<sub>WR</sub>) before another cycle can be initiated. The  $\overline{OE}$  control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled ( $\overline{CE}$  and  $\overline{OE}$  active) then  $\overline{WE}$  will disable the outputs in t<sub>ODW</sub> from its falling edge.

# DATA RETENTION MODE

The DS1225AB provides full functional capability for  $V_{CC}$  greater than 4.75 volts and write protects by 4.5 volts. The DS1225AD provides full-functional capability for  $V_{CC}$  greater than 4.5 volts and write protects by 4.25 volts. Data is maintained in the absence of  $V_{CC}$  without any additional support circuitry. The nonvolatile static RAMs constantly monitor  $V_{CC}$ . Should the supply voltage decay, the NV SRAMs automatically write protect themselves, all inputs become "don't care," and all outputs become high-impedance. As  $V_{CC}$  falls below approximately 3.0 volts, the power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when  $V_{CC}$  rises above approximately 3.0 volts, the power switching circuit connects the lithium energy source. Normal RAM operation can resume after  $V_{CC}$  exceeds 4.75 volts for the DS1225AB and 4.5 volts for the DS1225AD.

# FRESHNESS SEAL

Each DS1225 is shipped from Dallas Semiconductor with the lithium energy source disconnected, guaranteeing full energy capacity. When  $V_{CC}$  is first applied at a level of greater than  $V_{TP}$ , the lithium energy source is enabled for battery backup operation.

 $(T_A: See Note 10)$ 

# **ABSOLUTE MAXIMUM RATINGS\***

Voltage on Any Pin Relative to Ground Operating Temperature Storage Temperature Soldering Temperature Caution: Do Not Reflow -0.3V to +6.0V 0°C to 70°C; -40°C to +85°C for IND parts -40°C to +70°C; -40°C to +85°C for IND parts +260°C for 10 seconds (Wave or Hand Solder Only)

\* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

<b>RECOMMENDED DC OPERA</b>		(T <sub>A</sub> : See	Note 10)			
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
DS1225AB Power Supply Voltage	V <sub>CC</sub>	4.75	5.0	5.25	V	
DS1225AD Power Supply Voltage	V <sub>CC</sub>	4.50	5.0	5.5	V	
Logic 1	V <sub>IH</sub>	2.2		V <sub>CC</sub>	V	
Logic 0	V <sub>IL</sub>	0.0		+0.8	V	

 $(V_{CC} = 5V \pm 5\% \text{ for } DS1225AB)$  $(V_{CC} = 5V \pm 10\% \text{ for } DS1225AD)$ DC ELECTRICAL CHARACTERISTICS **PARAMETER** MIN TYP MAX UNITS NOTES **SYMBOL** Input Leakage Current -1.0 +1.0III. μA I/O Leakage Current -1.0 +1.0IIO μA  $\overline{CE} > V_{IH} < V_{CC}$ Output Current @ 2.4V I<sub>OH</sub> -1.0 mA Output Current @ 0.4V 2.0 IOL mA 5.0 Standby Current CE = 2.2V 10.0 mA I<sub>CCS1</sub> 3.0 5.0 Standby Current CE =  $V_{CC}$  - 0.5V I<sub>CCS2</sub> mA Operating Current 75  $I_{CC01}$ mA (Commercial) **Operating Current** 85 I<sub>CC01</sub> mA (Industrial) Write Protection Voltage  $V_{TP}$ 4.50 4.62 4.75 V (DS1225AB) Write Protection Voltage 4.25 4.37 4.5 V V<sub>TP</sub> (DS1225AD)

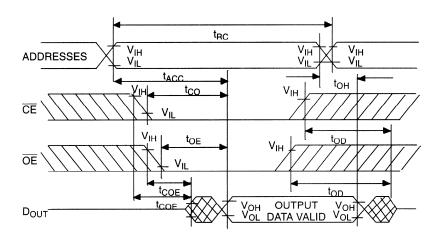
CAPACITANCE					(T	<sub>A</sub> =25°C)
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C <sub>IN</sub>		5	10	pF	
Input/Output Capacitance	C <sub>I/O</sub>		5	10	pF	

DS1225AB/AD 4.0

AC ELECTRICAL CHARACTERISTICS $(V_{cc} = 5V \pm 10\% \text{ for DS1225AD})$							
PARAMETER	SYMBOL		25AB-70 25AD-70		25AB-85	UNITS	NOTES
IARAWETER	SIMBOL	MIN	MAX	DS1225AD-85 MIN MAX		UNIIS	NOILS
Read Cycle Time	t <sub>RC</sub>	70		85		ns	
Access Time	t <sub>ACC</sub>		70		85	ns	
$\overline{OE}$ to Output Valid	t <sub>OE</sub>		35		45	ns	
$\overline{\text{CE}}$ to Output Valid	t <sub>CO</sub>		70		85	ns	
$\overline{OE}$ or $\overline{CE}$ to Output Active	t <sub>COE</sub>	5		5		ns	5
Output High Z from Deselection	t <sub>OD</sub>		25		30	ns	5
Output Hold from Address Change	t <sub>OH</sub>	5		5		ns	
Write Cycle Time	t <sub>WC</sub>	70		85		ns	
Write Pulse Width	t <sub>WP</sub>	55		65		ns	3
Address Setup Time	t <sub>AW</sub>	0		0		ns	
Write Recovery Time	t <sub>WR1</sub>	0		0		ns	12
	t <sub>WR2</sub>	10		10		ns	13
Output High Z from $\overline{WE}$	t <sub>ODW</sub>		25		30	ns	5
Output Active from $\overline{WE}$	t <sub>OEW</sub>	5		5		ns	5
Data Setup Time	t <sub>DS</sub>	30		35		ns	4
Data Hold Time	t <sub>DH1</sub>	0		0		ns	12
	t <sub>DH2</sub>	10		10		ns	13

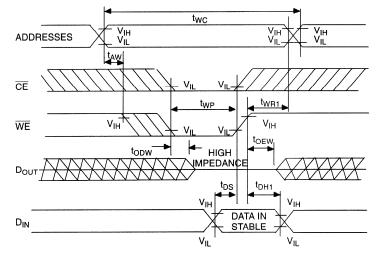
#### AC ELECTRICAL CHARACTERISTICS (cont'd) DS1225AB- 150 DS1225AB-200 DS1225AD- 150 PARAMETER SYMBOL DS1225AD-200 UNITS NOTES MAX MIN MAX MIN Read Cycle Time 150 200 t<sub>RC</sub> ns Access Time 150 200 t<sub>ACC</sub> ns 70 100 $\overline{\text{OE}}$ to Output Valid ns toE 150 200 $\overline{CE}$ to Output Valid $t_{CO}$ ns 5 $\overline{OE}$ or $\overline{CE}$ to Output Active 5 5 t<sub>COE</sub> ns Output High Z from Deselection t<sub>OD</sub> 35 35 ns 5 Output Hold from Address 5 5 t<sub>OH</sub> ns Change Write Cycle Time 200 150 twc ns Write Pulse Width 100 100 3 t<sub>WP</sub> ns Address Setup Time $t_{\rm AW}$ 0 0 ns Write Recovery Time 0 0 12 t<sub>WR1</sub> ns 10 10 13 t<sub>WR2</sub> ns 35 35 5 Output High Z from $\overline{WE}$ $t_{\text{ODW}}$ ns 5 Output Active from $\overline{WE}$ 5 5 toEW ns Data Setup Time 80 4 60 t<sub>DS</sub> ns Data Hold Time 0 0 12 ns t<sub>DH1</sub> 10 10 13 t<sub>DH2</sub> ns

# **READ CYCLE**



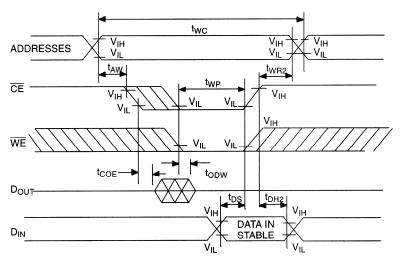
SEE NOTE 1

# WRITE CYCLE 1



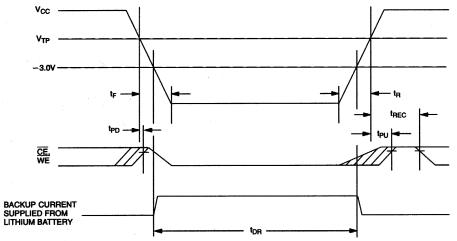
SEE NOTES 2, 3, 4, 6, 7, 8 AND 12

# WRITE CYCLE 2



SEE NOTES 2, 3, 4, 6, 7, 8 AND 13

# **POWER-DOWN/POWER-UP CONDITION**



SEE NOTE 11

POWER-DOWN/POWER-UP TIMING				(T	A : See I	Note 10)
PARAMETER SYMBOL MIN TYP			MAX	UNITS	NOTES	
$V_{CC}$ Fail Detect to $\overline{CE}$ and $\overline{WE}$ Inactive	t <sub>PD</sub>			1.5	μs	11
$V_{CC}$ slew from $V_{TP}$ to $0V$	t <sub>F</sub>	300			μs	
$V_{CC}$ slew from 0V to $V_{TP}$	t <sub>R</sub>	300			μs	
$V_{CC}$ Valid to $\overline{CE}$ and $\overline{WE}$ Inactive	t <sub>PU</sub>			2	ms	
V <sub>CC</sub> Valid to End of Write Protection	t <sub>REC</sub>			125	ms	

					(T <sub>A</sub>	$= 25^{\circ}C)$
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Expected Data Retention Time	t <sub>DR</sub>	10			years	9

## WARNING:

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

# NOTES:

- 1.  $\overline{\text{WE}}$  is high for a read cycle.
- 2.  $\overline{OE} = V_{IH}$  or  $V_{IL}$ . If  $\overline{OE} = V_{IH}$  during write cycle, the output buffers remain in a high-impedance state.
- 3. t<sub>WP</sub> is specified as the logical AND of  $\overline{CE}$  and  $\overline{WE}$ . t<sub>WP</sub> is measured from the latter of  $\overline{CE}$  or  $\overline{WE}$  going low to the earlier of  $\overline{CE}$  or  $\overline{WE}$  going high.
- 4.  $t_{DS}$  are measured from the earlier of  $\overline{CE}$  or  $\overline{WE}$  going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.
- 6. If the  $\overline{CE}$  low transition occurs simultaneously with or later than the  $\overline{WE}$  low transition, the output buffers remain in a high-impedance state during this period.
- 7. If the  $\overline{CE}$  high transition occurs prior to or simultaneously with the  $\overline{WE}$  high transition, the output buffers remain in a high-impedance state during this period.
- 8. If  $\overline{WE}$  is low or the  $\overline{WE}$  low transition occurs prior to or simultaneously with the  $\overline{CE}$  low transition, the output buffers remain in a high-impedance state during this period.
- 9. Each DS1225AB and each DS1225AD has a built-in switch that disconnects the lithium source until  $V_{CC}$  is first applied by the user. The expected  $t_{DR}$  is defined as accumulative time in the absence of  $V_{CC}$  starting from the time power is first applied by the user. This parameter is guaranteed by design and is not 100% tested.
- 10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C. For industrial products (IND), this range is -40°C to +85°C.
- 11. In a power down condition the voltage on any pin may not exceed the voltage on  $V_{\mbox{\scriptsize CC}}$  .
- 12.  $t_{WR1}$ ,  $t_{DH1}$  are measured from  $\overline{WE}$  going high.
- 13.  $t_{WR2}$ ,  $t_{DH2}$  are measured from  $\overline{CE}$  going high.
- 14. DS1225 modules are recognized by Underwriters Laboratory (U.L.®) under file E99151.

# DC TEST CONDITIONS

Outputs Open Cycle = 200ns for Operating Current All Voltages Are Referenced to Ground

# **AC TEST CONDITIONS**

Output Load: 100 pF + 1TTL Gate Input Pulse Levels: 0 - 3.0V Timing Measurement Reference Levels Input: 1.5V Output: 1.5V Input Pulse Rise and Fall Times: 5ns

# **ORDERING INFORMATION**

PART NUMBER	TEMPERATURE RANGE	SUPPLY TOLERANCE	PIN/PACKAGE	SPEED GRADE				
DS1225AB-70	$0^{\circ}C$ to $+70^{\circ}C$	$5V \pm 5\%$	28 / 720 EMOD	70ns				
DS1225AB-70+	$0^{\circ}C$ to $+70^{\circ}C$	$5V \pm 5\%$	28 / 720 EMOD	70ns				
DS1225AB-70IND	-40°C to +85°C	$5V \pm 5\%$	28 / 720 EMOD	70ns				
DS1225AB-70IND+	-40°C to +85°C	$5V \pm 5\%$	28 / 720 EMOD	70ns				
DS1225AB-85	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 5\%$	28 / 720 EMOD	85ns				
DS1225AB-85+	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 5\%$	28 / 720 EMOD	85ns				
DS1225AB-150	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 5\%$	28 / 720 EMOD	150ns				
DS1225AB-150+	$0^{\circ}$ C to $+70^{\circ}$ C	5V ± 5%	28 / 720 EMOD	150ns				
DS1225AB-150IND	-40°C to +85°C	5V ± 5%	28 / 720 EMOD	150ns				
DS1225AB-150IND+	-40°C to +85°C	$5V \pm 5\%$	28 / 720 EMOD	150ns				
DS1225AB-200	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 5\%$	28 / 720 EMOD	200ns				
DS1225AB-200+	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 5\%$	28 / 720 EMOD	200ns				
DS1225AB-200IND	-40°C to +85°C	$5V \pm 5\%$	28 / 720 EMOD	200ns				
DS1225AB-200IND+	-40°C to +85°C	$5V \pm 5\%$	28 / 720 EMOD	200ns				
DS1225AD-70	$0^{\circ}$ C to $+70^{\circ}$ C	5V ± 10%	28 / 720 EMOD	70ns				
DS1225AD-70+	$0^{\circ}$ C to $+70^{\circ}$ C	5V ± 10%	28 / 720 EMOD	70ns				
DS1225AD-70IND	-40°C to +85°C	5V ± 10%	28 / 720 EMOD	70ns				
DS1225AD-70IND+	-40°C to +85°C	$5V \pm 10\%$	28 / 720 EMOD	70ns				
DS1225AD-85	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 10\%$	28 / 720 EMOD	85ns				
DS1225AD-85+	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 10\%$	28 / 720 EMOD	85ns				
DS1225AD-150	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 10\%$	28 / 720 EMOD	150ns				
DS1225AD-150+	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 10\%$	28 / 720 EMOD	150ns				
DS1225AD-150IND	-40°C to +85°C	$5V \pm 10\%$	28 / 720 EMOD	150ns				
DS1225AD-150IND+	-40°C to +85°C	$5V \pm 10\%$	28 / 720 EMOD	150ns				
DS1225AD-200	0°C to +70°C	$5V \pm 10\%$	28 / 720 EMOD	200ns				
DS1225AD-200+	$0^{\circ}$ C to $+70^{\circ}$ C	$5V \pm 10\%$	28 / 720 EMOD	200ns				
DS1225AD-200IND	-40°C to +85°C	$5V \pm 10\%$	28 / 720 EMOD	200ns				
DS1225AD-200IND+	-40°C to +85°C	$5V \pm 10\%$	28 / 720 EMOD	200ns				

+ Denotes lead(Pb)-free/RoHS-compliant product.

# **PACKAGE INFORMATION**

For the latest package outline information and land patterns, go to <u>http://www.maxim-ic.com/packages</u>.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
28 EDIP	MDT28+2	<u>21-0245</u>

# **REVISION HISTORY**

REVISION	DESCRIPTION	PAGES CHANGED
DATE	Added package information table.	
121907	Removed the DIP module package drawing and dimension table.	9